

# Geländeplan/Plan of the fair grounds

- A1** Elektronik-Design (ED/EDA)
- A1** Messen und Prüfen
- A2** Micronano-Systeme
- A2** Servotechnik/Antriebsselemente
- A2** Sensorik
- A3** Displays
- A3 A4 A5 A6** Halbleiter
- A4** Wireless
- A6** Automotive
- A6** Embedded Systeme
- B1** Leiterplatten, andere unbestückte Schaltungsträger und EMS
- B2** Stromversorgung
- B3 B4 B5 C3** Elektromechanik/Systemperipherie  
– Verbindungskomponenten/-systeme  
– Schalter, Relais, Tastaturen  
– Gehäuse-technik
- B5 B6** Passive Bauelemente
- C4** Länderbeteiligungen aus Asien:  
Passive Bauelemente  
Elektromechanik/Systemperipherie
- in allen Hallen** Informationswesen und -dienstleistungen, Systemkomponenten

## electronica automotive

- ICM** electronica automotive conference
- A6** electronica automotive Forum Ausstellung

## electronica embedded

- A6** electronica embedded Forum Ausstellung

- A2** electronica Forum
- A3** e-Signage Forum
- B4** ZVEI Forum

- ICM** Wireless Congress Systems & Applications



- A1** Electronic design (ED/EDA)
- A1** Test and measurement
- A2** Micronano-systems
- A2** Servo-technology/drive elements
- A2** Sensor technology
- A3** Displays
- A3 A4 A5 A6** Semiconductors
- A4** Wireless
- A6** Automotive
- A6** Embedded systems
- B1** PCBs, other circuit carriers and EMS
- B2** Power supplies
- B3 B4 B5 C3** Electromechanics/system peripherals  
– Interconnection components/systems  
– Switches, relays, keyboards  
– Casing technology
- B5 B6** Passive components
- C4** Joint national exhibits from Asia:  
Passive components  
Electromechanics/system peripherals
- in all halls** Information gathering and services, Assemblies and subsystems

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